

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	7029	((118/715,723E) or (156/345.33, 345.34,345.43,345.47)).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/03 13:33
L3	632	2 and (showerhead or (shower head) or electrode plate or (gas (diffus\$4 or dispers\$4 or dispens\$4 or distribut\$4) plate)) same (nozzle or (injection device) or hole or orifice)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/12/03 13:38
L4	165	2 and (showerhead or (shower head) or electrode plate or (gas (diffus\$4 or dispers\$4 or dispens\$4 or distribut\$4) plate)) same (screw or bolt or fasten\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/12/03 17:57
L5	134	3 and 4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/12/03 21:54
L6	31	4 not 5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/12/03 15:53
L7	498	3 not (4 or 5 or 6)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/12/03 15:54
L8	2	("2003/0192645").URPN.	USPAT	ADJ	ON	2005/12/03 16:10
L9	0	("2003/0037880").URPN.	USPAT	ADJ	ON	2005/12/03 16:19
L10	0	("2001/0010257").URPN.	USPAT	ADJ	ON	2005/12/03 16:29

L11	35	("20030000913" "4033287" "4842683" "4924807" "4980204" "5070814" "5105761" "5194550" "5244501" "5282899" "5338399" "5366590" "5368685" "5698062" "5753132" "5788799" "5798016" "5843847" "5870271" "5886863" "5888309" "5980687" "6014943" "6063199" "6073577" "6108189" "6122159" "6165910" "6166897" "6174451" "6230651" "6251216" "6387287" "6403491").PN. OR ("6797639").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2005/12/03 16:33
L12	19	("20020136909" "4049523" "5338364" "5679167" "5728223" "5851294" "5950925" "5951771" "5962085" "6106625" "6110544" "6123776" "6132552" "6170432" "6213049" "6436193" "6444042").PN. OR ("6641673").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2005/12/03 16:37
L13	21	("3381114" "4401052" "4625678" "4748135" "4980204" "4993358" "5284519").PN. OR ("5728223").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2005/12/03 17:19
L14	215	2 and electrode same "electrode plate"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/12/03 18:05
L15	3	2 and (keyhole or key hole) same (screw or bolt or fasten\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/12/03 17:54
L16	17	(showerhead or (shower head) or electrode plate or (gas (diffus\$4 or dispers\$4 or dispens\$4 or distribut\$4) plate)) same (screw or bolt or fasten\$3) same (keyhole or (key hole) or (hole near3 slot))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/12/03 18:00
L17	10	electrode same "electrode plate" same (screw or bolt or fasten\$3) same (keyhole or (key hole) or (hole near3 slot))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/12/03 18:12

L18	86	(electrode same "electrode plate") and (screw or bolt or fasten\$3) and (keyhole or (key hole) or (hole near3 slot))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/12/03 18:18
L19	61	(18 and (@ad<="20031112" or @rlad<="20031112")) not (16 or 17)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/12/03 18:38
L20	30885	(screw or bolt or fasten\$3) same (keyhole or (key hole) or (hole near3 slot))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/12/03 18:33
L21	17	2 and 20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/12/03 18:18
L22	12082	(screw or bolt or fasten\$3) same (keyhole or (key hole))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/12/03 19:03
L23	464	22 and (substrate or wafer or workpiece)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/12/03 19:01
L24	21	23 and (etch\$3 or coat\$3 or deposit\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/12/03 18:37
L25	163	23 and (etch\$3 or coat\$3 or deposit\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/12/03 18:38

L26	122	(25 and (@ad<="20031112" or @rlad<="20031112"))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/12/03 18:38
L27	1849	(screw or bolt or fasten\$3) same (key-hole)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/12/03 19:00
L28	0	27 and (substrate or wafer or workpiece) and (etch\$3 or coat\$3or deposit\$3) (@ad<="20031112" or @rlad<="20031112")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/12/03 19:02
L29	1	27 and (substrate or wafer or workpiece) and (etch\$3 or coat\$3or deposit\$3) and (@ad<="20031112" or @rlad<="20031112")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/12/03 19:02
L30	18	2 and (keyhole or key-hole or (key hole))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/12/03 19:04
L32	2	("20010003271").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/03 21:55
S1	5	((("5959409") or ("4612077") or ("20030200929") or ("20030019580") or ("20020179011")).PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/02 23:16
S2	2	("20050098106").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/03 13:32